



IXYS LLC (A Littelfuse Company)
 1590 Buckeye Drive
 Milpitas, CA 95035

June 19, 2018

Certificate of Compliance RoHS 3

Herewith we confirm that
 IXYS Devices and Chip Products
 are in compliance with the requirements detailed in the
 DIRECTIVE 2015/863/EU of the EUROPEAN PARLIAMENT and of the COUNCIL

Exception: IXYS devices currently uses a high temperature leaded solder for chip attach allowable under RoHS exemption 7A until 2019 per Directive 2016/774/EU as of 18 May 2016 amending Annex II to Directive 2000/53/EC. The prior wording for 8e (RoHS 7a) was retained and will be reviewed in 2019 by the EUC.

7(a)	Lead in high melting temperature type solders (i.e. lead- based alloys containing 85 % by weight or more lead)
------	--

The following items are not contained in IXYS Milpitas devices:

1. Cadmium (CD)
2. Mercury (Hg)
3. Chromium VI (Cr+6)
4. Polybrominated Biphenyl (PBBs)
5. Polybrominated Diphenyl Ethers (PBDEs, including Deca-BDE)
6. Diisobutyl Phthalate (DIBP) CAS#84-69-5
7. Benzyl Butyl Phthalate (BBP) CAS#85-68-7
8. Bis(2-ethylhexyl) Phthalate (DEHP) CAS#117-81-7
9. Dibutyl Phthalate (DBP) CAS#84-74-2

Gordon Rosete
 Dept. Head of Quality Assurance
 IXYS Milpitas LLC